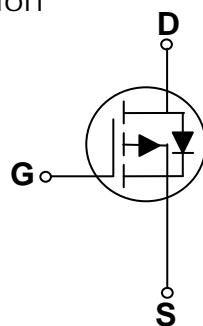
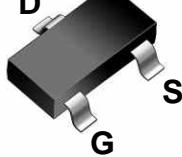


# -150V P-Channel MOSFETs

## General Description

These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

## SOT23-3S Pin Configuration



BVDSS	RDS(ON)	ID
-150V	750mΩ	-1A

## Features

- -150V, -1A, RDS(ON) = 750mΩ @ VGS = -10V
- Improved dv/dt capability
- Fast switching
- Green Device Available

## Applications

- Networking
- Load Switch
- LED applications

## Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	-150	V
V <sub>GS</sub>	Gate-Source Voltage	$\pm 20$	V
I <sub>D</sub>	Drain Current – Continuous ( $T_c=25^\circ\text{C}$ )	-1	A
	Drain Current – Continuous ( $T_c=100^\circ\text{C}$ )	-0.63	A
I <sub>DM</sub>	Drain Current – Pulsed <sup>1</sup>	-4	A
P <sub>D</sub>	Power Dissipation ( $T_c=25^\circ\text{C}$ )	1.56	W
	Power Dissipation – Derate above 25°C	0.012	W/°C
T <sub>STG</sub>	Storage Temperature Range	-50 to 150	°C
T <sub>J</sub>	Operating Junction Temperature Range	-50 to 150	°C

## Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
R <sub>θJA</sub>	Thermal Resistance Junction to ambient	---	80	°C/W

Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)

## Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_D=-250\mu\text{A}$	-150	---	---	V
$\text{I}_{\text{DSS}}$	Drain-Source Leakage Current	$V_{\text{DS}}=-150\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$	---	---	-1	$\mu\text{A}$
		$V_{\text{DS}}=-120\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=125^\circ\text{C}$	---	---	-10	$\mu\text{A}$
$\text{I}_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	$\text{nA}$

## On Characteristics

$\text{R}_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=-10\text{V}$ , $I_D=-1\text{A}$	---	650	800	$\text{m}\Omega$
		$V_{\text{GS}}=-6\text{V}$ , $I_D=-0.5\text{A}$	---	700	950	$\text{m}\Omega$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$ , $I_D = -250\mu\text{A}$	-2	-3	-4	V
$g_f$	Forward Transconductance	$V_{\text{DS}}=-10\text{V}$ , $I_D=-1\text{A}$	---	2	---	S

## Dynamic and switching Characteristics

$Q_g$	Total Gate Charge <sup>2,3</sup>	$V_{\text{DS}}=-75\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $I_D=-1\text{A}$	---	4.4	8	nC
$Q_{\text{gs}}$	Gate-Source Charge <sup>2,3</sup>		---	0.7	2	
$Q_{\text{gd}}$	Gate-Drain Charge <sup>2,3</sup>		---	1.5	3	
$T_{\text{d(on)}}$	Turn-On Delay Time <sup>2,3</sup>	$V_{\text{DD}}=-75\text{V}$ , $V_{\text{GS}}=-10\text{V}$ , $R_G=10\text{M}\Omega$ $I_D=-1\text{A}$	---	12.5	20	ns
$T_r$	Rise Time <sup>2,3</sup>		---	8.9	18	
$T_{\text{d(off)}}$	Turn-Off Delay Time <sup>2,3</sup>		---	17.3	36	
$T_f$	Fall Time <sup>2,3</sup>		---	11.5	24	
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=-25\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $F=1\text{MHz}$	---	430	700	pF
$C_{\text{oss}}$	Output Capacitance		---	38	60	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	28	56	
$R_g$	Gate resistance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , $F=1\text{MHz}$	---	30	60	$\Omega$

## Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_s$	Continuous Source Current	$V_G=V_D=0\text{V}$ , Force Current	---	---	-1	A
$I_{\text{SM}}$	Pulsed Source Current		---	---	-2	A
$V_{\text{SD}}$	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$ , $I_s=-1\text{A}$ , $T_J=25^\circ\text{C}$	---	---	-1	V

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width  $\leq 300\text{us}$  , duty cycle  $\leq 2\%$ .
3. Essentially independent of operating temperature.

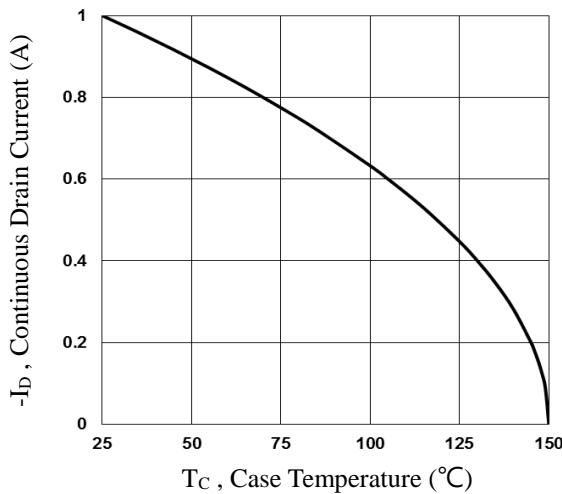


Fig.1 Continuous Drain Current vs.  $T_C$

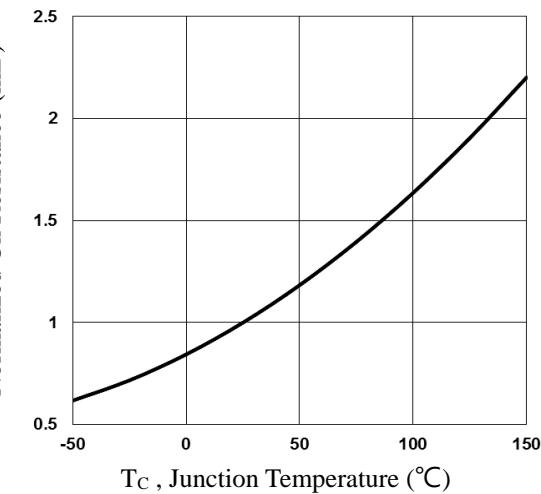


Fig.2 Continuous Drain Current vs.  $T_C$

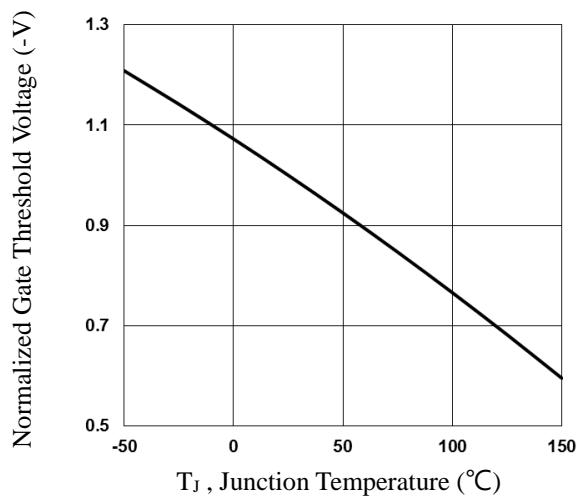


Fig.3 Normalized  $V_{th}$  vs.  $T_J$

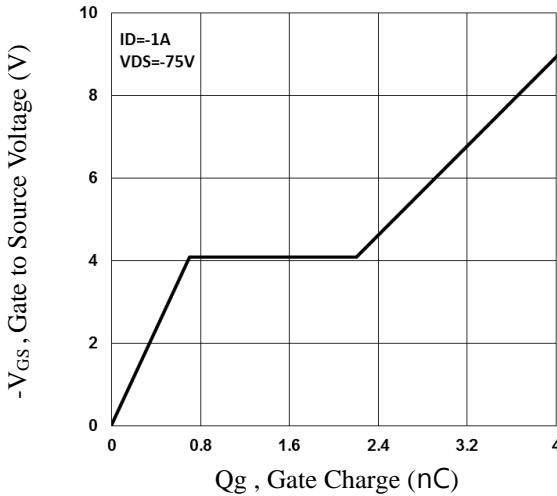


Fig.4 Gate Charge Waveform

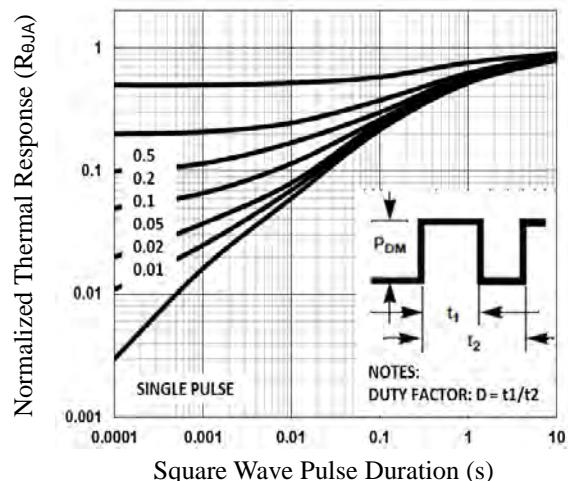


Fig.5 Normalized Transient Impedance

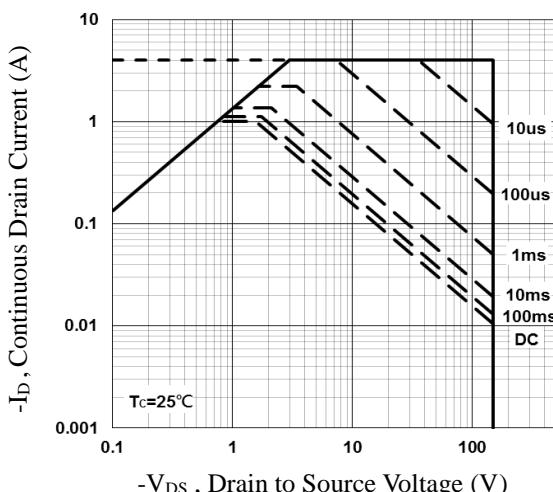


Fig.6 Maximum Safe Operation Area

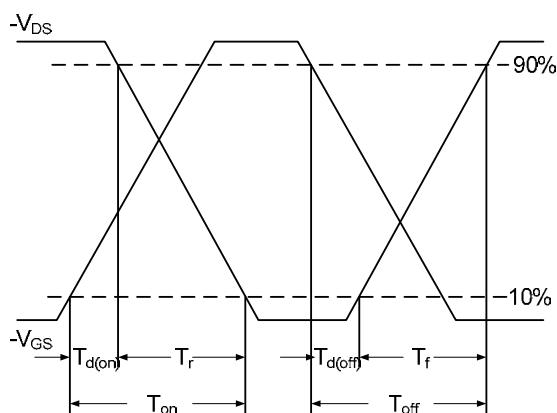


Fig.7 Switching Time Waveform

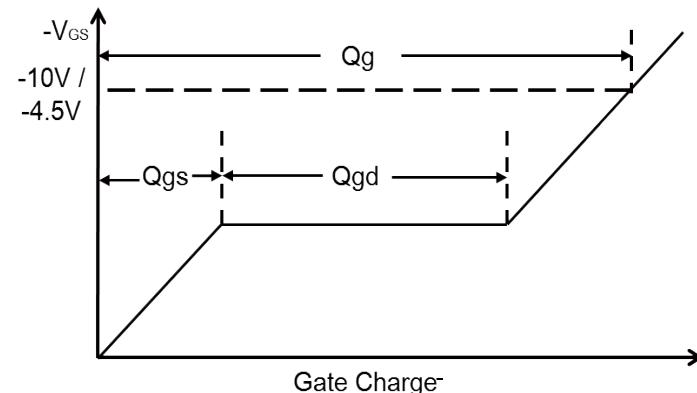
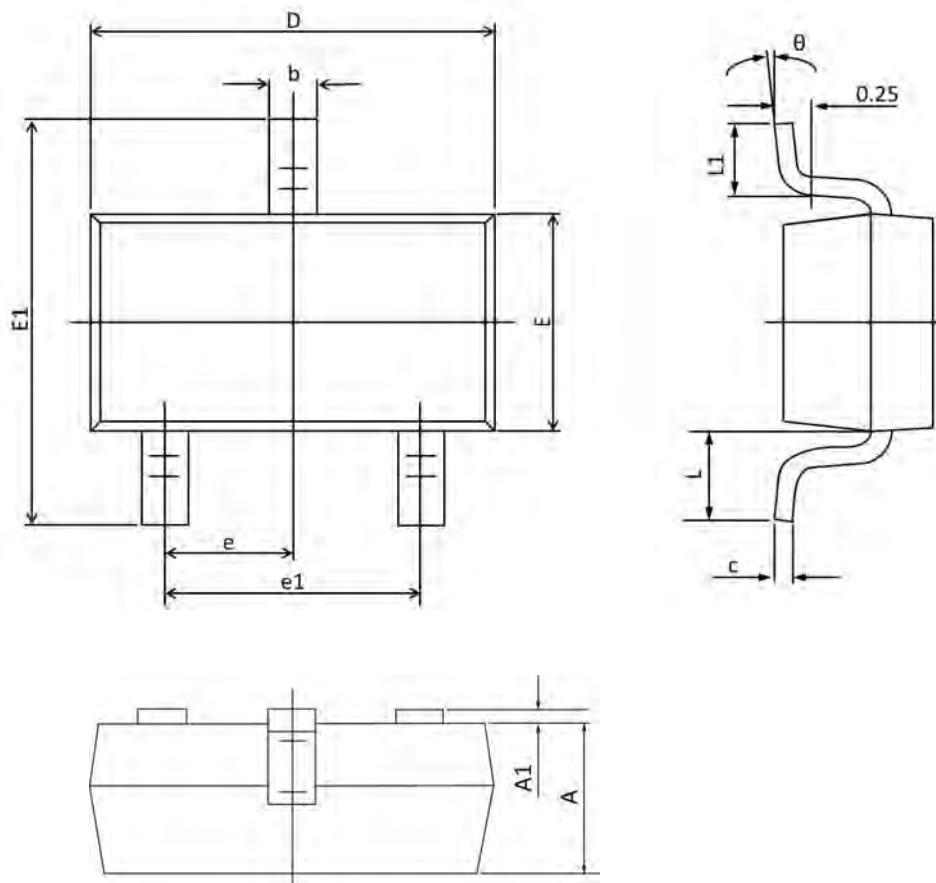


Fig.8 Gate Charge Waveform

## SOT23-3S PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.000	0.035	0.039
A1	0.000	0.100	0.000	0.004
b	0.300	0.500	0.012	0.020
c	0.090	0.110	0.003	0.004
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
Θ	1°	7°	1°	7°